QFN14 3.0x2.5, 0.5P
CASE 510CB
ISSUE O

DATE 31 AUG 2016

A. CONFORMS TO JEDEC REGISTRATION MO−241, VARIATION AA
B. DIMENSIONS ARE IN MILLIMETERS.
D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.

NOTES:

PIN #1 IDENT

BOTTOM VIEW

SIDE VIEW

TOP VIEW

RECOMMENDED LAND PATTERN

MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

98AON13643G

QFN14 3.0X2.5, 0.5P

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries.
ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.